Empty modules

"series 10 000"

Features

A series 10 000 module is made of three parts:

- Body of molded polyamide (holding the terminals).
- Two polyamide end plates of different thickness, which, snapped onto the body,protect the electronic components and determine the overail spacing.

	Components	
Spacing	Body	End plate
18	1 x EB	2 x PFN 1
23	1 x EB	(1 x PFN 1) + 1 x PFN 2)
28	1 x EB	2 x PFN 2

Accessories

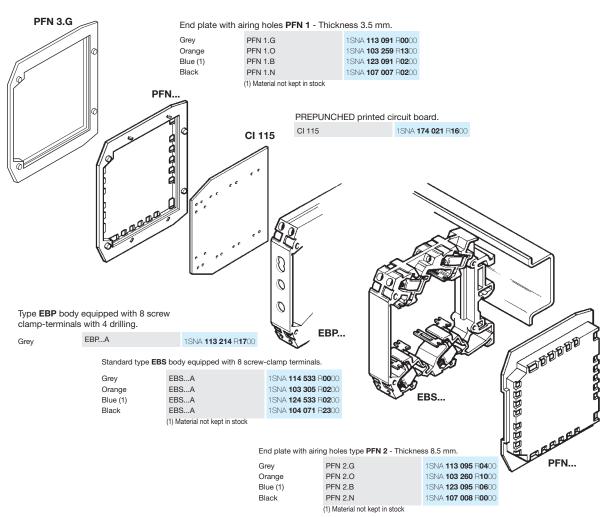
Marking method

RC55

see marking

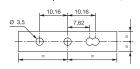
End plate without airing holes - Type PFN 3.

Grey PFN 3.G 1SNA 114 289 R2400



Option

Type "EBP" body with 4 holes for indicator or potentiometers, etc...





Standard "EBS" body



How to order

Indicate the part numbers of an insulator and the 2 end plates. **Example :** for a 23 mm spacing module equipped with 8 screw-clamp connections, you must order :

1 grey insulator	1SNA 114 533 R 00 00
1 grey end plate 3.5	1SNA 113 091 R 00 00
1 grey end plate 8.5	1SNA 113 095 R 04 00



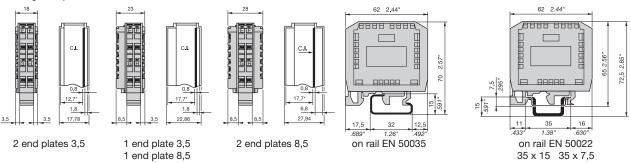
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Dimensions

Component holder spacing is determined by required internal volume for component packaging.

*: Max. height of components



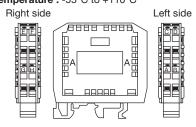
Electrical and mechanical characteristics

1. Electrical

TYPE OF CO	ONNECTION	SCREW-CLAMP A
Connecting	Rigid conductor	0 to 4 mm ²
Connecting capacity	Flexible conductor	0 to 2,5 mm ²
	AWG	20 to 12 AWG
	DIN Gr. C	250 V ~ and 300 V =
Rated voltage	NFC Cat. C	250 V ~ and =
Trated voltage	CSA	
Damada		wire stripping length 7 mm
Remarks		Ø recommended screwdriver 3,5 mm

2. Mechanical

Body: polyamide UL 94.V0 Working temperature: -40°C to +100°C Arc creepage index: KB 600 Storage temperature: -55°C to +110°C



3. Thermal

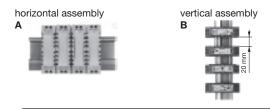
- For maximum reliability, the mounting method must be determined according to the power dissipated in the interface module, and the ambient temperature around the modules.

Convertor à macernum temperature et 188° - 70° C inside the module

Prover desepated

Maximum temperature near the modules

- Inversely, knowing the type of mounting, A or B, and the power dissipated, the curve (left) determines the maximum recommended ambient temperature.



The characteristics shown on the left are given as a guide and may be modified without notice

Accessories Printed circuit boards

Material : Epoxy resin UL94 V0 - Thickness of copper : 35 μm Prepunched boards

CI 115 1SNA 174 021 R1600

